CMOS Digital Integrated Circuits Silicon Monolithic

# 74VHC9273FT

#### 1. Functional Description

• Octal D-Type Flip-Flop with Clear

#### 2. General

The 74VHC9273FT is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse. When the  $\overline{\text{CLR}}$  input is held "L", the Q outputs are at a low logic level independent of the other inputs.

The  $\overline{\text{CLR}}$  input and CK input have hysteresis between the positive-going and negative-going thresholds. Thus the 74VHC9273FT is capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

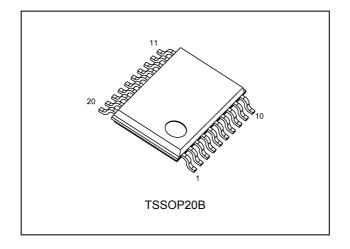
It is easy to wire on the board because Input terminals are at the opposite side of Output terminals.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### 3. Features

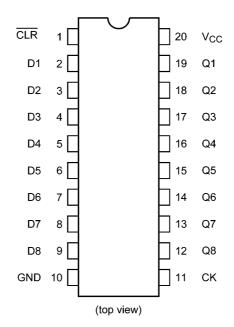
- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C
- (3) High speed:  $f_{MAX} = 195$  MHz (typ.) at  $V_{CC} = 5.0$  V
- (4) Low power dissipation:  $I_{CC} = 4.0 \ \mu A \ (max)$  at  $T_a = 25^{\circ}C$
- (5) Power-down protection is provided on all inputs.
- (6) Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- (7) Wide operating voltage range:  $V_{CC(opr)} = 2.0 \text{ V to } 5.5 \text{ V}$
- (8) Function compatible with 74VHC273
- (9) Input terminals are at the opposite side of Output terminals
- Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

#### 4. Packaging

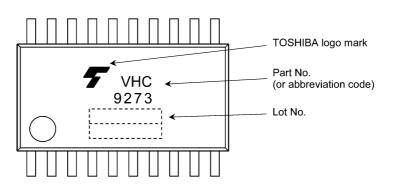


Start of commercial production 2014-06 2018-06-18 Rev.4.0

#### 5. Pin Assignment



#### 6. Marking



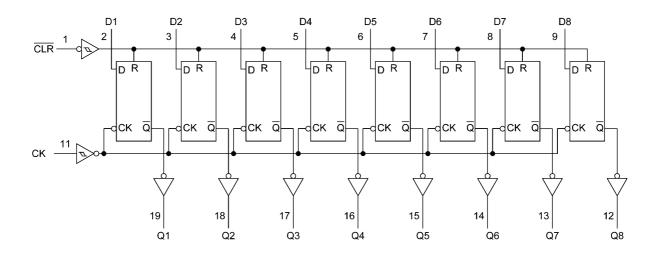
7. IEC Logic Symbol

#### 8. Truth Table

	Inputs		Output	Function
	D	СК	Q	Function
L	Х	Х	L	Clear
н	L		L	—
н	н		Н	—
н	Х		Qn	No Change

#### X: Don't care

#### 9. System Diagram



#### 10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>		-0.5 to 7.0	V
Output voltage	V <sub>OUT</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		-20	mA
Output diode current	I <sub>ОК</sub>		±20	mA
Output current	I <sub>OUT</sub>		±25	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±75	mA
Power dissipation	PD	(Note 1)	180	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of  $T_a = -40$  to 85 °C. From  $T_a = 85$  to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

#### 11. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 125	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

#### 12. Electrical Characteristics

#### 12.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Conditio	n	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Positive threshold voltage	VP	—	—		_	_	2.20	V
				4.5	_	_	3.15	
				5.5	_	_	3.85	
Negative threshold voltage	V <sub>N</sub>	—		3.0	0.90	_	_	V
				4.5	1.35	_	_	
				5.5	1.65	—	_	
Hysteresis voltage	V <sub>H</sub>	—		3.0	0.30	_	1.20	V
(CK, CLR)				4.5	0.40	—	1.40	
				5.5	0.50	_	1.60	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -50 μA	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I <sub>OH</sub> = -4 mA	3.0	2.58	_	_	
			I <sub>OH</sub> = -8 mA	4.5	3.94	_	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	
			I <sub>OL</sub> = 8 mA	4.5	_	_	0.36	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND	÷	0 to 5.5	_	_	±0.1	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	μA

#### 12.2. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 85 °C)

Characteristics	Symbol	Test Conditior	ı	V <sub>CC</sub> (V)	Min	Мах	Unit
Positive threshold voltage	VP	—		3.0	_	2.20	V
				4.5	_	3.15	
				5.5	_	3.85	
Negative threshold voltage	V <sub>N</sub>	—		3.0	0.90	_	V
				4.5	1.35	_	]
				5.5	1.65	—	
Hysteresis voltage	V <sub>H</sub>	—		3.0	0.30	1.20	V
(CK, CLR)				4.5	0.40	1.40	
				5.5	0.50	1.60	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	1
				4.5	4.4	—	
			I <sub>OH</sub> = -4 mA	3.0	2.48	_	]
			I <sub>OH</sub> = -8 mA	4.5	3.80	_	1
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	1
				4.5	_	0.1	1
			I <sub>OL</sub> = 4 mA	3.0	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5		0.44	1
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	40.0	μA

#### 12.3. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C)

Characteristics	Symbol	Test Conditior	ı	V <sub>CC</sub> (V)	Min	Max	Unit
Positive threshold voltage	V <sub>P</sub>	—		3.0	_	2.20	V
				4.5		3.15	
				5.5	_	3.85	]
Negative threshold voltage	V <sub>N</sub>	_		3.0	0.90	_	V
				4.5	1.35	_	
				5.5	1.65	_	
Hysteresis voltage	V <sub>H</sub>	_		3.0	0.30	1.20	V
(CK, CLR)				4.5	0.40	1.40	
				5.5	0.50	1.60	]
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	
				4.5	4.4	_	]
			I <sub>OH</sub> = -4 mA	3.0	2.40	_	]
			I <sub>OH</sub> = -8 mA	4.5	3.70	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	
				4.5	_	0.1	
			I <sub>OL</sub> = 4 mA	3.0	_	0.55	]
			I <sub>OL</sub> = 8 mA	4.5		0.55	]
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	±2.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	80.0	μA

#### 12.4. Timing Requirements (Unless otherwise specified, $T_a = 25^{\circ}C$ , Input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	—	$\textbf{3.3}\pm\textbf{0.3}$		5.5	ns
(CK)			$5.0\pm0.5$		5.0	
Minimum pulse width	t <sub>w(L)</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$		5.0	ns
(CLR)			$5.0\pm0.5$	_	5.0	
Minimum setup time	ts	—	$\textbf{3.3}\pm\textbf{0.3}$	_	6.0	ns
			$5.0\pm0.5$	_	4.5	
Minimum hold time	t <sub>h</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$	_	1.0	ns
			$5.0\pm0.5$	_	1.0	
Minimum removal time	t <sub>rem</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$	_	2.5	ns
(CLR)			$5.0\pm0.5$	_	2.0	

### 12.5. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85°C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	—	$\textbf{3.3}\pm\textbf{0.3}$	6.5	ns
(CK)			$5.0\pm0.5$	5.0	
Minimum pulse width	t <sub>w(L)</sub>	—	$3.3\pm0.3$	6.0	ns
(CLR)			$5.0\pm0.5$	5.0	
Minimum setup time	ts	—	$\textbf{3.3}\pm\textbf{0.3}$	7.0	ns
			$5.0\pm0.5$	4.5	
Minimum hold time	t <sub>h</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$	1.0	ns
			$5.0\pm0.5$	1.0	
Minimum removal time	t <sub>rem</sub>	_	$\textbf{3.3}\pm\textbf{0.3}$	2.5	ns
(CLR)			$5.0\pm0.5$	2.0	

#### 12.6. Timing Requirements

#### (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	—	$\textbf{3.3}\pm\textbf{0.3}$	6.5	ns
(CK)			$5.0\pm0.5$	5.0	
Minimum pulse width	t <sub>w(L)</sub>	—	$3.3\pm0.3$	6.0	ns
(CLR)			$5.0\pm0.5$	5.0	
Minimum setup time	t <sub>S</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$	8.0	ns
			$5.0\pm0.5$	5.0	1
Minimum hold time	t <sub>h</sub>	_	$\textbf{3.3}\pm\textbf{0.3}$	1.0	ns
			$5.0\pm0.5$	1.0	1
Minimum removal time	t <sub>rem</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$	3.5	ns
(CLR)			$5.0\pm0.5$	2.5	

#### 12.7. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	$V_{CC}$ (V)	$C_L (pF)$	Min	Тур.	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		—	$\textbf{3.3}\pm\textbf{0.3}$	15	—	5.7	11.8	ns
(CK-Q)					50	_	8.7	18.4	
				$5.0\pm0.5$	15	_	4.2	7.7	
					50	—	6.5	12.1	
Propagation delay time	t <sub>PHL</sub>		—	$\textbf{3.3}\pm\textbf{0.3}$	15	_	5.9	12.3	ns
(CLR-Q)					50	_	8.6	18.0	
				$5.0\pm0.5$	15	_	4.3	8.0	
					50	_	6.5	11.9	
Maximum clock frequency	f <sub>MAX</sub>		_	$\textbf{3.3}\pm\textbf{0.3}$	15	85	140	_	MHz
					50	50	75	_	
				$5.0\pm0.5$	15	130	195	_	
					50	80	100	_	
Output skew	t <sub>osLH</sub> ,t <sub>osHL</sub>	(Note 1)	_	$\textbf{3.3}\pm\textbf{0.3}$	50	_	_	1.5	ns
				$5.0\pm0.5$	50		_	1.0	
Input capacitance	C <sub>IN</sub>		_			_	4	10	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 2)	_			_	11	_	pF

Note 1: Parameter guaranteed by design.  $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$  (per bit)

And the total  $C_{PD}$  when n pcs.of flip flop operate can be calculated by the following equation.  $C_{PD}$  (total) = 7 + 4  $\times$  n

#### 12.8. AC Characteristics

#### (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		—	$\textbf{3.3}\pm\textbf{0.3}$	15	1.0	13.4	ns
(CK-Q)					50	1.0	20.9	
				$}5.0\pm 0.5$	15	1.0	8.8	
					50	1.0	13.8	
Propagation delay time	t <sub>PHL</sub>		_	$\textbf{3.3}\pm\textbf{0.3}$	15	1.0	14.0	ns
(CLR-Q)					50	1.0	20.6	
				$5.0\pm0.5$	15	1.0	9.1	
					50	1.0	13.6	
Maximum clock frequency	f <sub>MAX</sub>		_	$\textbf{3.3}\pm\textbf{0.3}$	15	75	_	MHz
					50	45	_	
				$5.0\pm0.5$	15	115	_	
					50	70	_	
Output skew	t <sub>osLH</sub> ,t <sub>osHL</sub>	(Note 1)		$3.3\pm 0.3$	50		1.5	ns
				$5.0\pm0.5$	50		1.0	
Input capacitance	C <sub>IN</sub>					_	10	pF

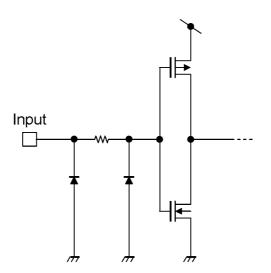
Note 1: Parameter guaranteed by design. ( $t_{osLH} = |t_{PLH}m-t_{PLH}n|$ ,  $t_{osHL} = |t_{PHL}m-t_{PHL}n|$ )

#### 12.9. AC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C, Input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	$C_L (pF)$	Min	Max	Unit
Propagation delay time (CK-Q)	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	$3.3\pm0.3$	15	1.0	14.5	ns
					50	1.0	23.0	
				$5.0\pm0.5$	15	1.0	10.0	
					50	1.0	15.0	
Propagation delay time (CLR-Q)	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	$\textbf{3.3}\pm\textbf{0.3}$	15	1.0	15.5	ns
					50	1.0	22.5	
				$5.0\pm0.5$	15	1.0	10.0	
					50	1.0	15.0	
Maximum clock frequency	f <sub>MAX</sub>			$\textbf{3.3}\pm\textbf{0.3}$	15	65	_	MHz
					50	40	_	
				$5.0\pm0.5$	15	100	_	
					50	60	_	
Output skew	t <sub>osLH</sub> ,t <sub>osHL</sub>	(Note 1)	_	$\textbf{3.3}\pm\textbf{0.3}$	50	_	1.5	ns
				$5.0\pm0.5$	50	_	1.0	
Input capacitance	C <sub>IN</sub>		_			_	10	pF

Note 1: Parameter guaranteed by design. ( $t_{osLH} = |t_{PLH}m-t_{PLH}n|$ ,  $t_{osHL} = |t_{PHL}m-t_{PHL}n|$ )

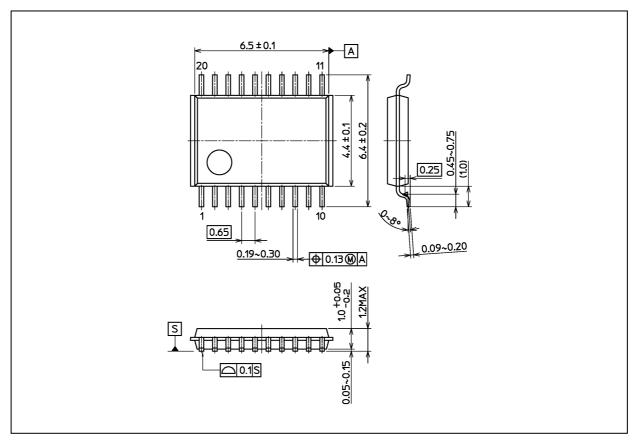
#### 13. Input Equivalent Circuit



### 74VHC9273FT

#### **Package Dimensions**

Unit: mm



Weight: 0.071 g (typ.)

	Package Name(s)
Nickname: TSSOP20B	

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 M74HC175B1R
 M74HC174RM13TR
 74ALVTH16374ZQLR
 74ALVTH32374ZKER

 74VHC9273FT(BJ)
 74VHCV374FT(BJ)
 74VHCV574FT(BJ)
 SN74LVC74ADR
 SN74HC574PWR
 SN74HC374AN
 SN74AS574DWR

 SN74ALS175NSR
 SN74HC175D
 SN74AC74D
 74AHC1G79GV.125
 74AHC74D.112
 74HC574D.652
 74HC173D.652
 74HC173PW.112

 74HC174PW.112
 74HC175DW.112
 74HC377DB.118
 74HC73D.652
 74HC173PW.112
 74HC173PW.112